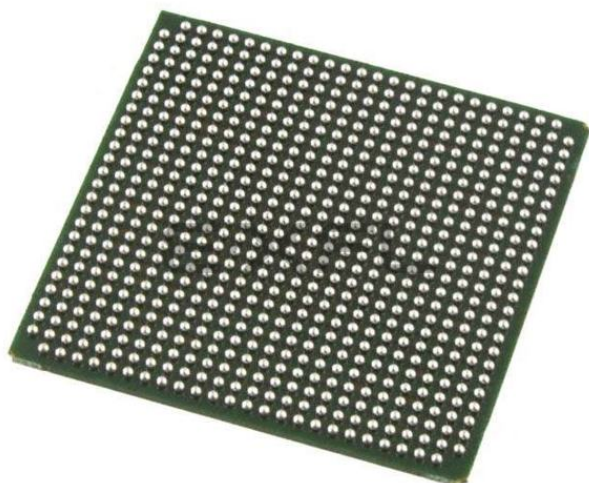




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

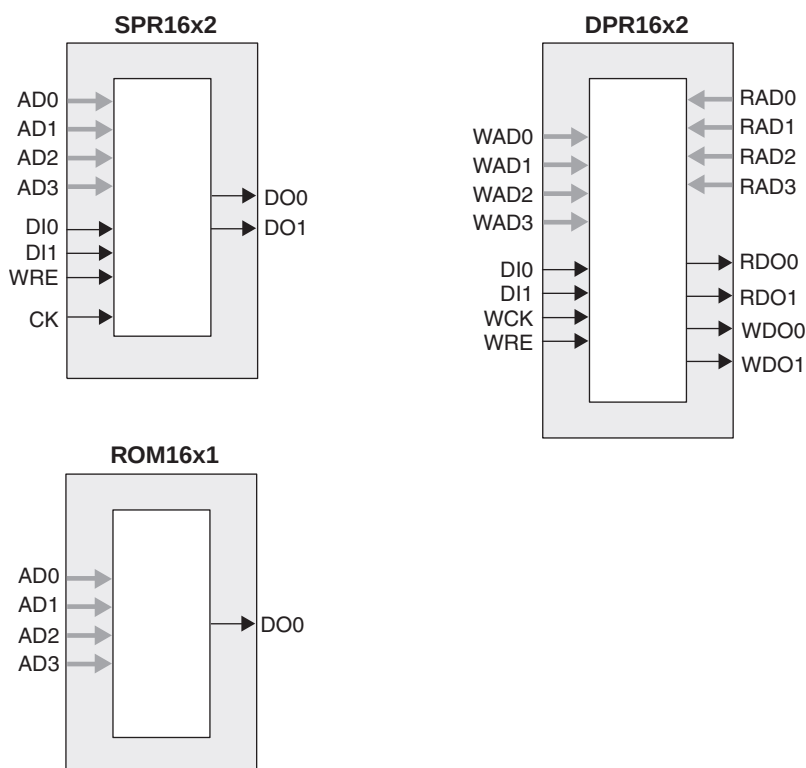
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	32800
Total RAM Bits	434176
Number of I/O	496
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec33e-4fn672i

Figure 2-5. Distributed Memory Primitives



ROM Mode: The ROM mode uses the same principal as the RAM modes, but without the Write port. Pre-loading is accomplished through the programming interface during configuration.

PFU Modes of Operation

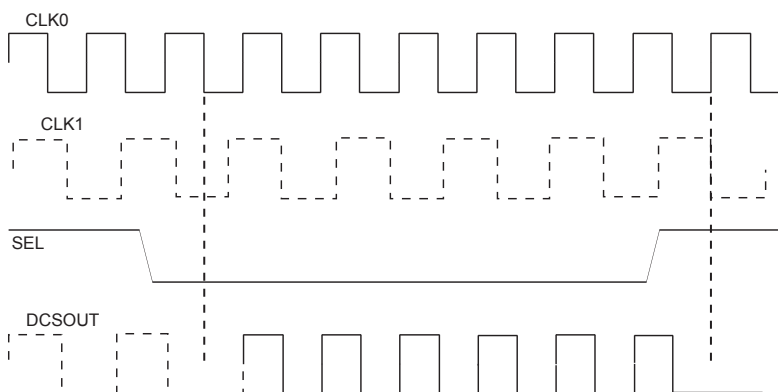
Slices can be combined within a PFU to form larger functions. Table 2-4 tabulates these modes and documents the functionality possible at the PFU level.

Table 2-4. PFU Modes of Operation

Logic	Ripple	RAM ¹	ROM
LUT 4x8 or MUX 2x1 x 8	2-bit Add x 4	SPR16x2 x 4 DPR16x2 x 2	ROM16x1 x 8
LUT 5x4 or MUX 4x1 x 4	2-bit Sub x 4	SPR16x4 x 2 DPR16x4 x 1	ROM16x2 x 4
LUT 6x 2 or MUX 8x1 x 2	2-bit Counter x 4	SPR16x8 x 1	ROM16x4 x 2
LUT 7x1 or MUX 16x1 x 1	2-bit Comp x 4		ROM16x8 x 1

1. These modes are not available in PFF blocks

Figure 2-14. DCS Waveforms



sysMEM Memory

The LatticeECP/EC devices contain a number of sysMEM Embedded Block RAM (EBR). The EBR consists of a 9-Kbit RAM, with dedicated input and output registers.

sysMEM Memory Block

The sysMEM block can implement single port, dual port or pseudo dual port memories. Each block can be used in a variety of depths and widths as shown in Table 2-6.

Table 2-6. sysMEM Block Configurations

Memory Mode	Configurations
Single Port	8,192 x 1
	4,096 x 2
	2,048 x 4
	1,024 x 9
	512 x 18
	256 x 36
True Dual Port	8,192 x 1
	4,096 x 2
	2,048 x 4
	1,024 x 9
	512 x 18
Pseudo Dual Port	8,192 x 1
	4,096 x 2
	2,048 x 4
	1,024 x 9
	512 x 18
	256 x 36

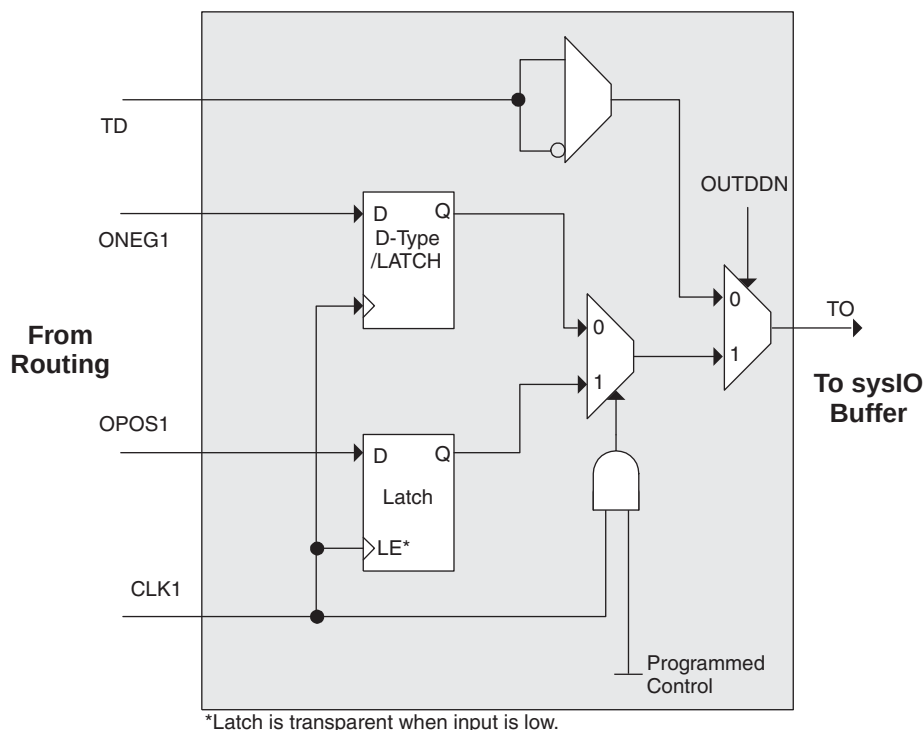
Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1 and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Figure 2-31. Tristate Register Block



Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing and a DQS signal provided from the programmable DQS pin. The clock can optionally be inverted.

The clock enable and local reset signals are selected from the routing and optionally inverted. The global tristate signal is passed through this block.

DDR Memory Support

Implementing high performance DDR memory interfaces requires dedicated DDR register structures in the input (for read operations) and in the output (for write operations). As indicated in the PIO Logic section, the LatticeEC devices provide this capability. In addition to these registers, the LatticeEC devices contain two elements to simplify the design of input structures for read operations: the DQS delay block and polarity control logic.

DLL Calibrated DQS Delay Block

Source Synchronous interfaces generally require the input clock to be adjusted in order to correctly capture data at the input register. For most interfaces a PLL is used for this adjustment. However in DDR memories the clock (referred to as DQS) is not free running so this approach cannot be used. The DQS Delay block provides the required clock alignment for DDR memory interfaces.

The DQS signal (selected PIOs only) feeds from the PAD through a DQS delay element to a dedicated DQS routing resource. The DQS signal also feeds polarity control logic, which controls the polarity of the clock to the sync registers in the input register blocks. Figures 2-32 and 2-33 show how the DQS transition signals are routed to the PIOs.

The temperature, voltage and process variations of the DQS delay block are compensated by a set of calibration (6-bit bus) signals from two DLLs on opposite sides of the device. Each DLL compensates DQS Delays in its half of the device as shown in Figure 2-33. The DLL loop is compensated for temperature, voltage and process variations by the system clock and feedback loop.

be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP/EC devices contain two possible ports that can be used for device configuration. The test access port (TAP), which supports bit-wide configuration, and the sysCONFIG port that supports both byte-wide and serial configuration.

The TAP supports both the IEEE Std. 1149.1 Boundary Scan specification and the IEEE Std. 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six of the I/Os used as dedicated pins and the rest being dual-use pins (please refer to TN1053 for more information about using the dual-use pins as general purpose I/O). There are four configuration options for LatticeECP/EC devices:

1. Industry standard SPI memories.
2. Industry standard byte wide flash and ispMACH 4000 for control/addressing.
3. Configuration from system microprocessor via the configuration bus or TAP.
4. Industry standard FPGA board memory.

On power-up, the FPGA SRAM is ready to be configured with the sysCONFIG port active. The IEEE 1149.1 serial mode can be activated any time after power-up by sending the appropriate command through the TAP port. Once a configuration port is selected, that port is locked and another configuration port cannot be activated until the next power-up sequence.

For more information about device configuration, please see the list of technical documentation at the end of this data sheet.

Internal Logic Analyzer Capability (ispTRACY)

All LatticeECP/EC devices support an internal logic analyzer diagnostic feature. The diagnostic features provide capabilities similar to an external logic analyzer, such as programmable event and trigger condition and deep trace memory. This feature is enabled by Lattice's ispTRACY. The ispTRACY utility is added into the user design at compile time.

For more information about ispTRACY, please see information regarding additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP/EC devices require a single external, 10K ohm +/- 1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

Supply Current (Standby)^{1, 2, 3, 4}

Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	LFEC1	6	mA
		LFEC3	10	mA
		LFEC6/LFEC6	15	mA
		LFEC10/LFEC10	25	mA
		LFEC15/LFEC15	35	mA
		LFEC20/LFEC20	60	mA
		LFEC33/LFEC33	85	mA
I_{CCAUX}	Auxiliary Power Supply Current		15	mA
I_{CCPLL}	PLL Power Supply Current		5	mA
I_{CCIO}	Bank Power Supply Current ⁶		2	mA
I_{CCJ}	V_{CCJ} Power Supply Current		5	mA

1. For further information about supply current, please see the list of technical documentation at the end of this data sheet.
2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
3. Frequency 0MHz.
4. Pattern represents a "blank" configuration data file.
5. $T_J=25^{\circ}\text{C}$, power supplies at nominal voltage.
6. Per bank.

LatticeECP/EC External Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-5		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{DQVBS}	Data Valid Before DQS	All	0.20	—	0.20	—	0.20	—	UI
t_{DQVAS}	Data Valid After DQS	All	0.20	—	0.20	—	0.20	—	UI
f_{MAX_DDR}	DDR Clock Frequency	All	95	200	95	166	95	133	MHz
Primary and Secondary Clock⁶									
$f_{MAX_PRI}^2$	Frequency for Primary Clock Tree	All	—	420	—	378	—	340	MHz
t_{W_PRI}	Clock Pulse Width for Primary Clock	All	1.19	—	1.19	—	1.19	—	ns
t_{SKEW_PRI}	Primary Clock Skew within an I/O Bank	All	—	250	—	300	—	350	ps

1. General timing numbers based on LVCMOS2.5V, 12 mA. Loading of 0 pF.

2. Using LVDS I/O standard.

3. DDR timing numbers based on SSTL I/O.

4. DDR specifications are characterized but not tested.

5. UI is average bit period.

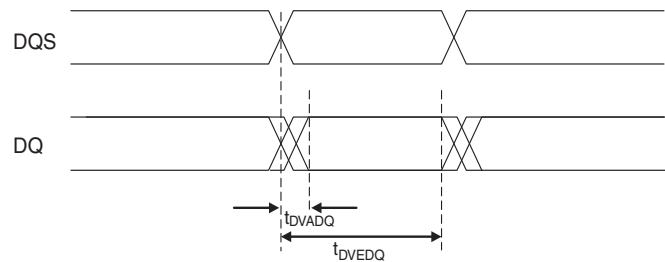
6. Based on a single primary clock.

7. These timing numbers were generated using ispLEVER design tool. Exact performance may vary with design and tool version. The tool uses internal parameters that have been characterized but are not tested on every device.

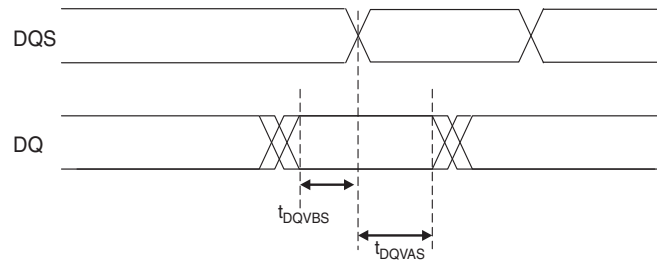
Timing v.G 0.30

Figure 3-5. DDR Timings

DQ and DQS Read Timings



DQ and DQS Write Timings



Signal Descriptions (Cont.)

Signal Name	I/O	Description
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data out pin used to shift data out of device using 1149.1.
V _{CCJ}	—	V _{CCJ} - The power supply pin for JTAG Test Access Port.
Configuration Pads (used during sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration modes values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI3 or SPIX mode.
CSN	I	sysCONFIG chip select (Active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (Active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (Active low).
D[7:0]/SPID[0:7]	I/O	sysCONFIG Port Data I/O.
DOUT/CSO	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPIN	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPIX modes.

Pin Information Summary

		LFEC1			LFEC3				LFEC6/EC6				LFEC6/EC10		
Pin Type		100-TQFP	144-TQFP	208-PQFP	100-TQFP	144-TQFP	208-PQFP	256-fpBGA	144-TQFP	208-PQFP	256-fpBGA	484-fpBGA	208-PQFP	256-fpBGA	484-fpBGA
Single Ended User I/O		67	97	112	67	97	145	160	97	147	195	224	147	195	288
Differential Pair User I/O		29	46	56	29	46	72	80	46	72	97	112	72	97	144
Configu-ration	Dedicated	13	13	13	13	13	13	13	13	13	13	13	13	13	13
	Muxed	48	48	48	48	48	48	48	48	48	48	48	56	56	56
TAP		5	5	5	5	5	5	5	5	5	5	5	5	5	5
Dedicated (total without supplies)		80	110	160	80	110	160	208	110	160	208	373	160	208	373
V _{CC}		2	3	3	2	3	3	10	4	4	10	20	6	10	20
V _{CCAUX}		2	2	2	4	4	4	4	2	4	2	12	4	2	12
V _{CCPLL}		0	0	0	0	0	0	0	0	0	0	0	0	0	0
V _{CCIO}	Bank0	1	2	2	1	2	3	2	2	3	2	4	3	2	4
	Bank1	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank2	1	1	1	2	2	2	2	1	2	2	4	2	2	4
	Bank3	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank4	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank5	1	2	2	1	2	2	2	2	3	2	4	3	2	4
	Bank6	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank7	1	1	1	2	2	2	2	1	2	2	4	2	2	4
GND, GND0-GND7		8	13	13	8	13	16	20	14	18	20	44	20	20	44
NC		0	2	51	0	2	9	35	0	4	0	139	0	0	75
Single Ended/Differential I/O Pair per Bank	Bank 0	11/5	14/7	16/8	11/5	14/7	26/13	32/16	14/7	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 1	11/5	13/6	16/8	11/5	13/6	16/8	16/8	13/6	17/8	18/9	32/16	17/8	18/9	32/16
	Bank 2	3/1	8/4	8/4	3/1	8/4	14/7	16/8	8/4	14/7	16/8	16/8	14/7	16/8	32/16
	Bank 3	8/4	13/6	16/8	8/4	13/6	16/8	16/8	13/6	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 4	12/4	14/6	16/8	12/4	14/6	16/8	16/8	14/6	17/8	17/8	32/16	17/8	17/8	32/16
	Bank 5	9/4	13/6	16/8	9/4	13/6	26/13	32/16	13/6	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 6	5/2	14/7	16/8	5/2	14/7	16/8	16/8	14/7	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 7	8/4	8/4	8/4	8/4	8/4	15/7	16/8	8/4	15/7	16/8	16/8	15/7	16/8	32/16
V _{CCJ}		1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.

LFEC1, LFEC3, LFEC6/EC6 Logic Signal Connections: 144 TQFP (Cont.)

Pin Number	LFEC1				LFEC3				LFEC6/EC6			
	Pin Function	Bank	LVD S	Dual Function	Pin Function	Bank	LVD S	Dual Function	Pin Function	Bank	LVD S	Dual Function
50	PB8B	5	C	VREF1_5	PB16B	5	C	VREF1_5	PB16B	5	C	VREF1_5
51	PB9A	5	T	PCLKT5_0	PB17A	5	T	PCLKT5_0	PB17A	5	T	PCLKT5_0
52	GND5	5			GND5	5			GND5	5		
53	PB9B	5	C	PCLKC5_0	PB17B	5	C	PCLKC5_0	PB17B	5	C	PCLKC5_0
54	VCCAUX	-			VCCAUX	-			VCCAUX	-		
55	VCCIO4	4			VCCIO4	4			VCCIO4	4		
56	PB10A	4	T	WRITEN	PB18A	4	T	WRITEN	PB18A	4	T	WRITEN
57	PB10B	4	C	CS1N	PB18B	4	C	CS1N	PB18B	4	C	CS1N
58	PB11A	4	T	VREF1_4	PB19A	4	T	VREF1_4	PB19A	4	T	VREF1_4
59	PB11B	4	C	CSN	PB19B	4	C	CSN	PB19B	4	C	CSN
60	PB12A	4	T	VREF2_4	PB20A	4	T	VREF2_4	PB20A	4	T	VREF2_4
61	PB12B	4	C	D0/SPID7	PB20B	4	C	D0/SPID7	PB20B	4	C	D0/SPID7
62	PB13A	4	T	D2/SPID5	PB21A	4	T	D2/SPID5	PB21A	4	T	D2/SPID5
63	GND4	4			GND4	4			GND4	4		
64	PB13B	4	C	D1/SPID6	PB21B	4	C	D1/SPID6	PB21B	4	C	D1/SPID6
65	PB14A	4	T	BDQS14	PB22A	4	T	BDQS22	PB22A	4	T	BDQS22
66	PB14B	4	C	D3/SPID4	PB22B	4	C	D3/SPID4	PB22B	4	C	D3/SPID4
67	PB15A	4	T		PB23A	4	T		PB23A	4	T	
68	PB15B	4	C	D4/SPID3	PB23B	4	C	D4/SPID3	PB23B	4	C	D4/SPID3
69	PB16B	4		D5/SPID2	PB24B	4		D5/SPID2	PB24B	4		D5/SPID2
70	PB17B	4		D6/SPID1	PB25B	4		D6/SPID1	PB25B	4		D6/SPID1
71	VCCIO4	4			VCCIO4	4			VCCIO4	4		
72*	GND3 GND4	-			GND3 GND4	-			GND3 GND4	-		
73	VCCIO3	3			VCCIO3	3			VCCIO3	3		
74	PR14A	3		VREF1_3	PR18A	3		VREF1_3	PR27A	3		VREF1_3
75	PR12B	3	C		PR16B	3	C		PR25B	3	C	
76	PR12A	3	T		PR16A	3	T		PR25A	3	T	
77	PR11B	3	C		PR15B	3	C		PR24B	3	C	
78	PR11A	3	T	RDQS11	PR15A	3	T	RDQS15	PR24A	3	T	RDQS24
79	PR10B	3	C	RLM0_PLLC_FB_A	PR14B	3	C	RLM0_PLLC_FB_A	PR23B	3	C	RLM0_PLLC_FB_A
80	GND3	3			GND3	3			GND3	3		
81	PR10A	3	T	RLM0_PLLT_FB_A	PR14A	3	T	RLM0_PLLT_FB_A	PR23A	3	T	RLM0_PLLT_FB_A
82	PR9B	3	C	RLM0_PLLC_IN_A	PR13B	3	C	RLM0_PLLC_IN_A	PR22B	3	C	RLM0_PLLC_IN_A
83	PR9A	3	T	RLM0_PLLT_IN_A	PR13A	3	T	RLM0_PLLT_IN_A	PR22A	3	T	RLM0_PLLT_IN_A
84	VCCIO3	3			VCCIO3	3			VCCIO3	3		
85	PR8B	3	C	DI/CSSPIN	PR12B	3	C	DI/CSSPIN	PR21B	3	C	DI/CSSPIN
86	PR8A	3	T	DOUT/CSON	PR12A	3	T	DOUT/CSON	PR21A	3	T	DOUT/CSON
87	PR7B	3	C	BUSY/SISPI	PR11B	3	C	BUSY/SISPI	PR20B	3	C	BUSY/SISPI
88	PR7A	3	T	D7/SPID0	PR11A	3	T	D7/SPID0	PR20A	3	T	D7/SPID0
89	CFG2	3			CFG2	3			CFG2	3		
90	CFG1	3			CFG1	3			CFG1	3		
91	CFG0	3			CFG0	3			CFG0	3		
92	VCC	-			VCC	-			VCC	-		
93	PROGRAMN	3			PROGRAMN	3			PROGRAMN	3		
94	CCLK	3			CCLK	3			CCLK	3		
95	INITN	3			INITN	3			INITN	3		
96	GND	-			GND	-			GND	-		
97	DONE	3			DONE	3			DONE	3		
98	GND	-			GND	-			GND	-		

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
169	PT13A	1	T		PT21A	1	T	
170	PT12B	1	C		PT20B	1	C	
171	PT12A	1	T		PT20A	1	T	
172	PT11B	1	C	VREF2_1	PT19B	1	C	VREF2_1
173	PT11A	1	T	VREF1_1	PT19A	1	T	VREF1_1
174	PT10B	1	C		PT18B	1	C	
175	PT10A	1	T		PT18A	1	T	
176	VCCIO1	1			VCCIO1	1		
177	VCCAUX	-			VCCAUX	-		
178	PT9B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0
179	GND0	0			GND0	0		
180	PT9A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0
181	PT8B	0	C	VREF1_0	PT16B	0	C	VREF1_0
182	PT8A	0	T	VREF2_0	PT16A	0	T	VREF2_0
183	PT7B	0	C		PT15B	0	C	
184	PT7A	0	T		PT15A	0	T	
185	PT6B	0	C		PT14B	0	C	
186	PT6A	0	T	TDQS6	PT14A	0	T	TDQS14
187	VCCIO0	0			VCCIO0	0		
188	PT5B	0	C		PT13B	0	C	
189	NC	-			GND0	0		
190	PT5A	0	T		PT13A	0	T	
191	PT4B	0	C		PT12B	0	C	
192	PT4A	0	T		PT12A	0	T	
193	PT3B	0	C		PT11B	0	C	
194	PT3A	0	T		PT11A	0	T	
195	PT2B	0	C		PT10B	0	C	
196	PT2A	0	T		PT10A	0	T	
197	NC	-			VCCIO0	0		
198	NC	-			PT6B	0	C	
199	NC	-			PT6A	0	T	TDQS6
200	NC	-			PT5B	0	C	
201	NC	-			PT5A	0	T	
202	NC	-			PT4B	0	C	
203	NC	-			PT4A	0	T	
204	NC	-			PT3B	0	C	
205	NC	-			PT3A	0	T	
206	NC	-			PT2B	0	C	
207	NC	-			PT2A	0	T	
208	VCCIO0	0			VCCIO0	0		

* Double bonded to the pin.

LFEC6P/EC6, LFEC6P/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC6P/EC6				LFEC6P/EC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
127	CFG0	3			CFG0	3		
128	VCC	-			VCC	-		
129	PROGRAMN	3			PROGRAMN	3		
130	CCLK	3			CCLK	3		
131	INITN	3			INITN	3		
132	GND	-			GND	-		
133	DONE	3			DONE	3		
134	GND	-			GND	-		
135	VCC	-			VCC	-		
136	VCCAUX	-			VCCAUX	-		
137	PR9B	2	C	PCLKC2_0	PR18B	2	C	PCLKC2_0
138	GND2	2			GND2	2		
139	PR9A	2	T	PCLKT2_0	PR18A	2	T	PCLKT2_0
140	PR8B	2	C		PR17B	2	C	
141	PR8A	2	T		PR17A	2	T	
142	PR7B	2	C		PR16B	2	C	
143	PR7A	2	T		PR16A	2	T	
144	PR6B	2	C		PR15B	2	C	
145	VCCIO2	2			VCCIO2	2		
146	PR6A	2	T	RDQS6	PR15A	2	T	RDQS15
147	PR5B	2	C		PR14B	2	C	
148	PR5A	2	T		PR14A	2	T	
149	PR4B	2	C		PR13B	2	C	
150	PR4A	2	T		PR13A	2	T	
151	NC	-			GND	-		
152	NC	-			VCC	-		
153	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2
154	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2
155	VCCIO2	2			VCCIO2	2		
156*	GND1 GND2	-			GND1 GND2	-		
157	VCCIO1	1			VCCIO1	1		
158	PT33A	1			PT41A	1		
159	PT25B	1	C		PT33B	1	C	
160	PT25A	1	T		PT33A	1	T	
161	PT24B	1	C		PT32B	1	C	
162	PT24A	1	T		PT32A	1	T	
163	PT23B	1	C		PT31B	1	C	
164	PT23A	1	T		PT31A	1	T	
165	PT22B	1	C		PT30B	1	C	
166	PT22A	1	T	TDQS22	PT30A	1	T	TDQS30
167	PT21B	1	C		PT29B	1	C	
168	GND1	1			GND1	1		

LFEC10/EC10 and LFEC15/EC15 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC10/LFEC10				LFEC15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
P14	PR35B	3	C		PR43B	3	C	
P15	PR35A	3	T		PR43A	3	T	
R15	PR34B	3	C		PR42B	3	C	
R16	PR34A	3	T		PR42A	3	T	
M13	PR33B	3	C		PR41B	3	C	
M14	PR33A	3	T	RDQS33	PR41A	3	T	RDQS41
P16	PR32B	3	C	RLM0_PLLC_FB_A	PR40B	3	C	RLM0_PLLC_FB_A
GND	GND3	3			GND3	3		
N16	PR32A	3	T	RLM0_PLLT_FB_A	PR40A	3	T	RLM0_PLLT_FB_A
N15	PR31B	3	C	RLM0_PLLC_IN_A	PR39B	3	C	RLM0_PLLC_IN_A
M15	PR31A	3	T	RLM0_PLLT_IN_A	PR39A	3	T	RLM0_PLLT_IN_A
M16	PR30B	3	C	DI/CSSPIN	PR38B	3	C	DI/CSSPIN
L16	PR30A	3	T	DOUT/CSON	PR38A	3	T	DOUT/CSON
K16	PR29B	3	C	BUSY/SISPI	PR37B	3	C	BUSY/SISPI
J16	PR29A	3	T	D7/SPID0	PR37A	3	T	D7/SPID0
L12	CFG2	3			CFG2	3		
L14	CFG1	3			CFG1	3		
L13	CFG0	3			CFG0	3		
K13	PROGRAMN	3			PROGRAMN	3		
L15	CCLK	3			CCLK	3		
K15	INITN	3			INITN	3		
K14	DONE	3			DONE	3		
GND	GND3	3			GND3	3		
H16	PR27B	3	C		PR31B	3	C	
-	-	-			GND3	3		
H15	PR27A	3	T		PR31A	3	T	
G16	PR26B	3	C		PR30B	3	C	
G15	PR26A	3	T		PR30A	3	T	
K12	PR25B	3	C		PR29B	3	C	
J12	PR25A	3	T		PR29A	3	T	
J14	PR24B	3	C		PR28B	3	C	
J15	PR24A	3	T	RDQS24	PR28A	3	T	RDQS28
F16	PR23B	3	C		PR27B	3	C	
GND	GND3	3			GND3	3		
F15	PR23A	3	T		PR27A	3	T	
J13	PR22B	3	C		PR26B	3	C	
H13	PR22A	3	T		PR26A	3	T	
H14	PR21B	3	C		PR25B	3	C	
G14	PR21A	3	T		PR25A	3	T	
E16	PR20B	3	C		PR24B	3	C	
E15	PR20A	3	T		PR24A	3	T	
H12	PR18B	2	C	PCLKC2_0	PR22B	2	C	PCLKC2_0
GND	GND2	2			GND2	2		

LFEC6P/EC6, LFEC6P/EC10, LFEC6P/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC6P/EC6					LFEC6P/EC10					LFEC6P/EC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
N13	GND	-			N13	GND	-			N13	GND	-		
N14	GND	-			N14	GND	-			N14	GND	-		
N9	GND	-			N9	GND	-			N9	GND	-		
P10	GND	-			P10	GND	-			P10	GND	-		
P11	GND	-			P11	GND	-			P11	GND	-		
P12	GND	-			P12	GND	-			P12	GND	-		
P13	GND	-			P13	GND	-			P13	GND	-		
P14	GND	-			P14	GND	-			P14	GND	-		
P9	GND	-			P9	GND	-			P9	GND	-		
R15	GND	-			R15	GND	-			R15	GND	-		
R8	GND	-			R8	GND	-			R8	GND	-		
J16	VCC	-			J16	VCC	-			J16	VCC	-		
J7	VCC	-			J7	VCC	-			J7	VCC	-		
K16	VCC	-			K16	VCC	-			K16	VCC	-		
K17	VCC	-			K17	VCC	-			K17	VCC	-		
K6	VCC	-			K6	VCC	-			K6	VCC	-		
K7	VCC	-			K7	VCC	-			K7	VCC	-		
L17	VCC	-			L17	VCC	-			L17	VCC	-		
L6	VCC	-			L6	VCC	-			L6	VCC	-		
M17	VCC	-			M17	VCC	-			M17	VCC	-		
M6	VCC	-			M6	VCC	-			M6	VCC	-		
N16	VCC	-			N16	VCC	-			N16	VCC	-		
N17	VCC	-			N17	VCC	-			N17	VCC	-		
N6	VCC	-			N6	VCC	-			N6	VCC	-		
N7	VCC	-			N7	VCC	-			N7	VCC	-		
P16	VCC	-			P16	VCC	-			P16	VCC	-		
P7	VCC	-			P7	VCC	-			P7	VCC	-		
G11	VCCIO0	0			G11	VCCIO0	0			G11	VCCIO0	0		
H10	VCCIO0	0			H10	VCCIO0	0			H10	VCCIO0	0		
H11	VCCIO0	0			H11	VCCIO0	0			H11	VCCIO0	0		
H9	VCCIO0	0			H9	VCCIO0	0			H9	VCCIO0	0		
G12	VCCIO1	1			G12	VCCIO1	1			G12	VCCIO1	1		
H12	VCCIO1	1			H12	VCCIO1	1			H12	VCCIO1	1		
H13	VCCIO1	1			H13	VCCIO1	1			H13	VCCIO1	1		
H14	VCCIO1	1			H14	VCCIO1	1			H14	VCCIO1	1		
J15	VCCIO2	2			J15	VCCIO2	2			J15	VCCIO2	2		
K15	VCCIO2	2			K15	VCCIO2	2			K15	VCCIO2	2		
L15	VCCIO2	2			L15	VCCIO2	2			L15	VCCIO2	2		
L16	VCCIO2	2			L16	VCCIO2	2			L16	VCCIO2	2		
M15	VCCIO3	3			M15	VCCIO3	3			M15	VCCIO3	3		
M16	VCCIO3	3			M16	VCCIO3	3			M16	VCCIO3	3		
N15	VCCIO3	3			N15	VCCIO3	3			N15	VCCIO3	3		
P15	VCCIO3	3			P15	VCCIO3	3			P15	VCCIO3	3		
R12	VCCIO4	4			R12	VCCIO4	4			R12	VCCIO4	4		
R13	VCCIO4	4			R13	VCCIO4	4			R13	VCCIO4	4		
R14	VCCIO4	4			R14	VCCIO4	4			R14	VCCIO4	4		
T12	VCCIO4	4			T12	VCCIO4	4			T12	VCCIO4	4		
R10	VCCIO5	5			R10	VCCIO5	5			R10	VCCIO5	5		
R11	VCCIO5	5			R11	VCCIO5	5			R11	VCCIO5	5		
R9	VCCIO5	5			R9	VCCIO5	5			R9	VCCIO5	5		

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFEC20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A21	PT51A	1	T		A21	PT51A	1	T	
E17	PT50B	1	C		E17	PT50B	1	C	
B17	PT50A	1	T		B17	PT50A	1	T	
C17	PT49B	1	C		C17	PT49B	1	C	
GND	GND1	1			GND	GND1	1		
D17	PT49A	1	T		D17	PT49A	1	T	
F17	PT48B	1	C		F17	PT48B	1	C	
E20	PT48A	1	T		E20	PT48A	1	T	
G17	PT47B	1	C		G17	PT47B	1	C	
B20	PT47A	1	T		B20	PT47A	1	T	
E16	PT46B	1	C		E16	PT46B	1	C	
A20	PT46A	1	T	TDQS46	A20	PT46A	1	T	TDQS46
A19	PT45B	1	C		A19	PT45B	1	C	
GND	GND1	1			GND	GND1	1		
B19	PT45A	1	T		B19	PT45A	1	T	
D16	PT44B	1	C		D16	PT44B	1	C	
C16	PT44A	1	T		C16	PT44A	1	T	
F16	PT43B	1	C		F16	PT43B	1	C	
A18	PT43A	1	T		A18	PT43A	1	T	
G16	PT42B	1	C		G16	PT42B	1	C	
B18	PT42A	1	T		B18	PT42A	1	T	
A17	PT41B	1	C		A17	PT41B	1	C	
GND	GND1	1			GND	GND1	1		
A16	PT41A	1	T		A16	PT41A	1	T	
D15	PT40B	1	C		D15	PT40B	1	C	
B16	PT40A	1	T		B16	PT40A	1	T	
E15	PT39B	1	C		E15	PT39B	1	C	
C15	PT39A	1	T		C15	PT39A	1	T	
F15	PT38B	1	C		F15	PT38B	1	C	
G15	PT38A	1	T	TDQS38	G15	PT38A	1	T	TDQS38
B15	PT37B	1	C		B15	PT37B	1	C	
GND	GND1	1			GND	GND1	1		
A15	PT37A	1	T		A15	PT37A	1	T	
E14	PT36B	1	C		E14	PT36B	1	C	
G14	PT36A	1	T		G14	PT36A	1	T	
D14	PT35B	1	C	VREF2_1	D14	PT35B	1	C	VREF2_1
E13	PT35A	1	T	VREF1_1	E13	PT35A	1	T	VREF1_1
F14	PT34B	1	C		F14	PT34B	1	C	
C14	PT34A	1	T		C14	PT34A	1	T	
B14	PT33B	0	C	PCLKC0_0	B14	PT33B	0	C	PCLKC0_0
GND	GND0	0			GND	GND0	0		
A14	PT33A	0	T	PCLKT0_0	A14	PT33A	0	T	PCLKT0_0

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFEC20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
D13	PT32B	0	C	VREF1_0	D13	PT32B	0	C	VREF1_0
C13	PT32A	0	T	VREF2_0	C13	PT32A	0	T	VREF2_0
A13	PT31B	0	C		A13	PT31B	0	C	
B13	PT31A	0	T		B13	PT31A	0	T	
F13	PT30B	0	C		F13	PT30B	0	C	
F12	PT30A	0	T	TDQS30	F12	PT30A	0	T	TDQS30
A12	PT29B	0	C		A12	PT29B	0	C	
GND	GND0	0			GND	GND0	0		
B12	PT29A	0	T		B12	PT29A	0	T	
A11	PT28B	0	C		A11	PT28B	0	C	
B11	PT28A	0	T		B11	PT28A	0	T	
D12	PT27B	0	C		D12	PT27B	0	C	
C12	PT27A	0	T		C12	PT27A	0	T	
B10	PT26B	0	C		B10	PT26B	0	C	
A10	PT26A	0	T		A10	PT26A	0	T	
G12	PT25B	0	C		G12	PT25B	0	C	
GND	GND0	0			GND	GND0	0		
A9	PT25A	0	T		A9	PT25A	0	T	
E12	PT24B	0	C		E12	PT24B	0	C	
B9	PT24A	0	T		B9	PT24A	0	T	
F11	PT23B	0	C		F11	PT23B	0	C	
A8	PT23A	0	T		A8	PT23A	0	T	
D11	PT22B	0	C		D11	PT22B	0	C	
C11	PT22A	0	T	TDQS22	C11	PT22A	0	T	TDQS22
B8	PT21B	0	C		B8	PT21B	0	C	
GND	GND0	0			GND	GND0	0		
B7	PT21A	0	T		B7	PT21A	0	T	
E11	PT20B	0	C		E11	PT20B	0	C	
A7	PT20A	0	T		A7	PT20A	0	T	
G11	PT19B	0	C		G11	PT19B	0	C	
C7	PT19A	0	T		C7	PT19A	0	T	
G10	PT18B	0	C		G10	PT18B	0	C	
C6	PT18A	0	T		C6	PT18A	0	T	
C10	PT17B	0	C		C10	PT17B	0	C	
GND	GND0	0			GND	GND0	0		
D10	PT17A	0	T		D10	PT17A	0	T	
F10	PT16B	0	C		F10	PT16B	0	C	
A6	PT16A	0	T		A6	PT16A	0	T	
E10	PT15B	0	C		E10	PT15B	0	C	
C9	PT15A	0	T		C9	PT15A	0	T	
G9	PT14B	0	C		G9	PT14B	0	C	
D9	PT14A	0	T	TDQS14	D9	PT14A	0	T	TDQS14

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A5	PT13B	0	C		A5	PT13B	0	C	
GND	GND0	0			GND	GND0	0		
A4	PT13A	0	T		A4	PT13A	0	T	
F9	PT12B	0	C		F9	PT12B	0	C	
B6	PT12A	0	T		B6	PT12A	0	T	
E9	PT11B	0	C		E9	PT11B	0	C	
C8	PT11A	0	T		C8	PT11A	0	T	
G8	PT10B	0	C		G8	PT10B	0	C	
B5	PT10A	0	T		B5	PT10A	0	T	
A3	PT9B	0	C		A3	PT9B	0	C	
GND	GND0	0			GND	GND0	0		
A2	PT9A	0	T		A2	PT9A	0	T	
F8	PT8B	0	C		F8	PT8B	0	C	
B4	PT8A	0	T		B4	PT8A	0	T	
E8	PT7B	0	C		E8	PT7B	0	C	
B3	PT7A	0	T		B3	PT7A	0	T	
D8	PT6B	0	C		D8	PT6B	0	C	
G7	PT6A	0	T	TDQS6	G7	PT6A	0	T	TDQS6
C4	PT5B	0	C		C4	PT5B	0	C	
C5	PT5A	0	T		C5	PT5A	0	T	
E7	PT4B	0	C		E7	PT4B	0	C	
D4	PT4A	0	T		D4	PT4A	0	T	
F7	PT3B	0	C		F7	PT3B	0	C	
D6	PT3A	0	T		D6	PT3A	0	T	
D7	PT2B	0	C		D7	PT2B	0	C	
E6	PT2A	0	T		E6	PT2A	0	T	
GND	GND0	0			GND	GND0	0		
K10	GND	-			K10	GND	-		
K11	GND	-			K11	GND	-		
K12	GND	-			K12	GND	-		
K13	GND	-			K13	GND	-		
K14	GND	-			K14	GND	-		
K15	GND	-			K15	GND	-		
K16	GND	-			K16	GND	-		
L10	GND	-			L10	GND	-		
L11	GND	-			L11	GND	-		
L12	GND	-			L12	GND	-		
L13	GND	-			L13	GND	-		
L14	GND	-			L14	GND	-		
L15	GND	-			L15	GND	-		
L16	GND	-			L16	GND	-		
L17	GND	-			L17	GND	-		

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
J14	VCCIO1	1			J14	VCCIO1	1		
J15	VCCIO1	1			J15	VCCIO1	1		
J16	VCCIO1	1			J16	VCCIO1	1		
J17	VCCIO1	1			J17	VCCIO1	1		
K17	VCCIO2	2			K17	VCCIO2	2		
K18	VCCIO2	2			K18	VCCIO2	2		
L18	VCCIO2	2			L18	VCCIO2	2		
M18	VCCIO2	2			M18	VCCIO2	2		
N18	VCCIO2	2			N18	VCCIO2	2		
N19	VCCIO2	2			N19	VCCIO2	2		
P18	VCCIO3	3			P18	VCCIO3	3		
P19	VCCIO3	3			P19	VCCIO3	3		
R18	VCCIO3	3			R18	VCCIO3	3		
R19	VCCIO3	3			R19	VCCIO3	3		
T18	VCCIO3	3			T18	VCCIO3	3		
U18	VCCIO3	3			U18	VCCIO3	3		
V14	VCCIO4	4			V14	VCCIO4	4		
V15	VCCIO4	4			V15	VCCIO4	4		
V16	VCCIO4	4			V16	VCCIO4	4		
V17	VCCIO4	4			V17	VCCIO4	4		
W14	VCCIO4	4			W14	VCCIO4	4		
W15	VCCIO4	4			W15	VCCIO4	4		
V10	VCCIO5	5			V10	VCCIO5	5		
V11	VCCIO5	5			V11	VCCIO5	5		
V12	VCCIO5	5			V12	VCCIO5	5		
V13	VCCIO5	5			V13	VCCIO5	5		
W12	VCCIO5	5			W12	VCCIO5	5		
W13	VCCIO5	5			W13	VCCIO5	5		
P8	VCCIO6	6			P8	VCCIO6	6		
P9	VCCIO6	6			P9	VCCIO6	6		
R8	VCCIO6	6			R8	VCCIO6	6		
R9	VCCIO6	6			R9	VCCIO6	6		
T9	VCCIO6	6			T9	VCCIO6	6		
U9	VCCIO6	6			U9	VCCIO6	6		
K9	VCCIO7	7			K9	VCCIO7	7		
L9	VCCIO7	7			L9	VCCIO7	7		
M8	VCCIO7	7			M8	VCCIO7	7		
M9	VCCIO7	7			M9	VCCIO7	7		
N8	VCCIO7	7			N8	VCCIO7	7		
N9	VCCIO7	7			N9	VCCIO7	7		
G13	VCCAUX	-			G13	VCCAUX	-		
H20	VCCAUX	-			H20	VCCAUX	-		

LatticeEC Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC10E-4F256C	195	-4	fpBGA	256	COM	10.2K
LFEC10E-5F256C	195	-5	fpBGA	256	COM	10.2K
LFEC10E-3Q208C	147	-3	PQFP	208	COM	10.2K
LFEC10E-4Q208C	147	-4	PQFP	208	COM	10.2K
LFEC10E-5Q208C	147	-5	PQFP	208	COM	10.2K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC15E-3F484C	352	-3	fpBGA	484	COM	15.3K
LFEC15E-4F484C	352	-4	fpBGA	484	COM	15.3K
LFEC15E-5F484C	352	-5	fpBGA	484	COM	15.3K
LFEC15E-3F256C	195	-3	fpBGA	256	COM	15.3K
LFEC15E-4F256C	195	-4	fpBGA	256	COM	15.3K
LFEC15E-5F256C	195	-5	fpBGA	256	COM	15.3K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC20E-3F672C	400	-3	fpBGA	672	COM	19.7K
LFEC20E-4F672C	400	-4	fpBGA	672	COM	19.7K
LFEC20E-5F672C	400	-5	fpBGA	672	COM	19.7K
LFEC20E-3F484C	360	-3	fpBGA	484	COM	19.7K
LFEC20E-4F484C	360	-4	fpBGA	484	COM	19.7K
LFEC20E-5F484C	360	-5	fpBGA	484	COM	19.7K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC33E-3F672C	496	-3	fpBGA	672	COM	32.8K
LFEC33E-4F672C	496	-4	fpBGA	672	COM	32.8K
LFEC33E-5F672C	496	-5	fpBGA	672	COM	32.8K
LFEC33E-3F484C	360	-3	fpBGA	484	COM	32.8K
LFEC33E-4F484C	360	-4	fpBGA	484	COM	32.8K
LFEC33E-5F484C	360	-5	fpBGA	484	COM	32.8K

LatticeECP Industrial (Continued)

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP20E-3FN672I	400	-3	Lead-Free fpBGA	672	IND	19.7K
LFCEP20E-4FN672I	400	-4	Lead-Free fpBGA	672	IND	19.7K
LFCEP20E-3FN484I	400	-3	Lead-Free fpBGA	484	IND	19.7K
LFCEP20E-4FN484I	400	-4	Lead-Free fpBGA	484	IND	19.7K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP33E-3FN672I	496	-3	Lead-Free fpBGA	672	IND	32.8K
LFCEP33E-4FN672I	496	-4	Lead-Free fpBGA	672	IND	32.8K
LFCEP33E-3FN484I	360	-3	Lead-Free fpBGA	484	IND	32.8K
LFCEP33E-4FN484I	360	-4	Lead-Free fpBGA	484	IND	32.8K

Date	Version	Section	Change Summary
September 2005	02.0	Architecture	sysIO section has been updated.
		DC & Switching Characteristics	Recommended Operating Conditions has been updated with V_{CCPLL} .
			DC Electrical Characteristics table has been updated
			Removed 5V Tolerant Input Buffer section.
			Register-to-Register performance table has been updated (rev. G 0.28).
			LatticeECP/EC External Switching Characteristics table has been updated (rev. G 0.28).
			LatticeECP/EC Internal Switching Characteristics table has been updated (rev. G 0.28).
			LatticeECP/EC Family Timing Adders have been updated (rev. G 0.28).
			sysCLOCK PLL timing table has been updated (rev. G 0.28)
			LatticeECP/EC sysCONFIG Port Timing specification table has been updated (rev. G 0.28).
			Master Clock table has been updated (rev. G 0.28).
			JTAG Port Timing specification table has been updated (rev. G 0.28).
		Pinout Information	Signal Description table has been updated with V_{CCPLL} .
November 2005	02.1	DC & Switching Characteristics	Pin-to-Pin Performance table has been updated (G 0.30) - 4:1MUX, 8:1MUX, 16:1MUX, 32:1MUX
			Register-to-Register Performance (G 0.30) - No timing number changes.
			External Switching Characteristics (G 0.30) - No timing number changes.
			Internal Switching Characteristics (G 0.30) t_{SUP_DSP} , t_{HP_DSP} , t_{SUO_DSP} , t_{HO_DSP} , t_{COI_DSP} , t_{COD_DSP} numbers have been updated.
			Family Timing Adders (G 0.30) - No timing number changes.
			sysCLOCK PLL Timing (G 0.30) - No timing number changes.
			sysCONFIG Port Timing Specifications (G 0.30) - No timing number changes.
			Master Clock (G 0.30) - No timing number changes.
			JTAG Port Timing Specification (G 0.30) - No timing number changes.
		Ordering Information	Added 208-PQFP lead-free part numbers.
March 2006	02.2	DC & Switching Characteristics	Added footnote 3. to V_{CCAUX} in the Recommended Operating Conditions table.
January 2007	02.3	Architecture	EBR Asynchronous Reset section added.
February 2007	02.4	Architecture	Updated EBR Asynchronous Reset section.
			Updated Maximum Number of Elements in a Block table - MAC value for x9 changed to 2.
May 2007	02.5	Architecture	Updated text in Ripple Mode section.
November 2007	02.6	DC & Switching Characteristics	Added JTAG Port Waveforms diagram.
			Updated t_{RST} timing information in the sysCLOCK PLL Timing table.
		Pinout Information	Added Thermal Management text section.
		Supplemental Information	Updated title list.
February 2008	02.7	DC & Switching Characteristics	Read/Write Mode (Normal) and Read/Write Mode with Input and Output Registers waveforms in the EBR Memory Timing Diagrams section have been updated.
September 2012	02.8	All	Updated document with new corporate logo.